Matched N-Channel JFET Pairs

PRODUCT SUMMARY					
Part Number	$V_{GS(off)}$ (V)	$V_{(BR)GSS}$ Min (V)	g_{fs} Min (mS)	I_G Typ (pA)	$\|V_{GS1} - V_{GS2}\|$ Max (mV)
2N5564	–0.5 to –3	–40	7.5	–3	5
2N5565	–0.5 to –3	–40	7.5	–3	10
2N5566	–0.5 to –3	–40	7.5	–3	20

FEATURES

- Two-Chip Design
- High Slew Rate
- Low Offset/Drift Voltage
- Low Gate Leakage: 3 pA
- Low Noise: 12 nV/√Hz @ 10 Hz
- Good CMRR: 76 dB
- Minimum Parasitics

BENEFITS

- Tight Differential Match vs. Current
- Improved Op Amp Speed, Settling Time Accuracy
- Minimum Input Error/Trimming Requirement
- Insignificant Signal Loss/Error Voltage
- High System Sensitivity
- Minimum Error with Large Input Signals
- Maximum High Frequency Performance

APPLICATIONS

- Wideband Differential Amps
- High-Speed, Temp-Compensated, Single-Ended Input Amps
- High-Speed Comparators
- Impedance Converters
- Matched Switches

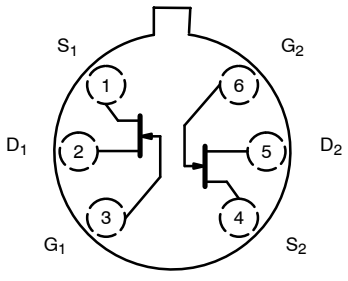
DESCRIPTION

The 2N5564/5565/5566 are matched pairs of JFETs mounted in a TO-71 package. This two-chip design reduces parasitics for good performance at high frequency while ensuring extremely tight matching. This series features high breakdown voltage ($V_{(BR)DSS}$ typically > 55 V), high gain (typically > 9 mS), and <5 mV offset between the two die.

The hermetically-sealed TO-71 package is available with full military processing (see Military Information).

For similar products see the low-noise U/SST401 series, and the low-leakage 2N5196/5197/5198/5199 data sheets.

TO-71



Top View

ABSOLUTE MAXIMUM RATINGS

Gate-Drain, Gate-Source Voltage . . . . . –40 V
Gate-Gate Voltage . . . . . ±80 V
Gate Current . . . . . 50 mA
Lead Temperature ($^1/_{16}$" from case for 10 sec.) . . . . . 300 °C
Storage Temperature . . . . . –65 to 200°C

Operating Junction Temperature . . . . . –55 to 150°C
Power Dissipation : Per Side[a] . . . . . 325 mW
Total[b] . . . . . 650 mW

Notes
a. Derate 2.6 mW/°C above 25°C
b. Derate 5.2 mW/°C above 25°C

SPECIFICATIONS (T_A = 25°C UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test Conditions	Typ[a]	Limits 2N5564 Min	2N5564 Max	2N5565 Min	2N5565 Max	2N5566 Min	2N5566 Max	Unit
Static										
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	I_G = −1 μA, V_{DS} = 0 V	−55	−40		−40		−40		V
Gate-Source Cutoff Voltage	$V_{GS(off)}$	V_{DS} = 15 V, I_D = 1 nA	−2	−0.5	−3	−0.5	−3	−0.5	−3	V
Saturation Drain Current[b]	I_{DSS}	V_{DS} = 15 V, V_{GS} = 0 V	20	5	30	5	30	5	30	mA
Gate Reverse Current	I_{GSS}	V_{GS} = −20 V, V_{DS} = 0 V	−5		−100		−100		−100	pA
		T_A = 150°C	−10		−200		−200		−200	nA
Gate Operating Current[c]	I_G	V_{DG} = 15 V, I_D = 2 mA	−3							pA
		T_A = 125°C	−1							nA
Drain-Source On-Resistance	$r_{DS(on)}$	V_{GS} = 0 V, I_D = 1 mA	50		100		100		100	Ω
Gate-Source Voltage[c]	V_{GS}	V_{DG} = 15 V, I_D = 2 mA	−1.2							V
Gate-Source Forward Voltage	$V_{GS(F)}$	I_G = 2 mA , V_{DS} = 0 V	0.7		1		1		1	V
Dynamic										
Common-Source Forward Transconductance	g_{fs}	V_{DS} = 15 V, I_D = 2 mA f = 1 kHz	9	7.5	12.5	7.5	12.5	7.5	12.5	mS
Common-Source Output Conductance	g_{os}		35		45		45		45	μS
Common-Source Forward Transconductance[d]	g_{fs}	V_{DS} = 15 V, I_D = 2 mA f = 100 MHz	8.5	7		7		7		mS
Common-Source Input Capacitance	C_{iss}	V_{DS} = 15 V, I_D = 2 mA f = 1 MHz	10		12		12		12	pF
Common-Source Reverse Transfer Capacitance	C_{rss}		2.5		3		3		3	pF
Equivalent Input Noise Voltage	$\overline{e}_n$	V_{DS} = 15 V, I_D = 2 mA f = 10 Hz	12		50		50		50	$\frac{nV}{\sqrt{Hz}}$
Noise Figure	NF	R_G = 10 MΩ			1		1		1	dB
Matching										
Differential Gate-Source Voltage	$\lvert V_{GS1} - V_{GS2} \rvert$	V_{DG} = 15 V, I_D = 2 mA			5		10		20	mV
Gate-Source Voltage Differential Change with Temperature	$\frac{\Delta \lvert V_{GS1} - V_{GS2} \rvert}{\Delta T}$	V_{DG} = 15 V, I_D = 2 mA T_A = −55 to 125°C			10		25		50	$\frac{\mu V}{°C}$
Saturation Drain Current Ratio[c]	$\frac{I_{DSS1}}{I_{DSS2}}$	V_{DS} = 15 V, V_{GS} = 0 V	0.98	0.95	1	0.95	1	0.95	1	
Transconductance Ratio	$\frac{g_{fs1}}{g_{fs2}}$	V_{DS} = 15 V, I_D = 2 mA f = 1 kHz	0.98	0.95	1	0.90	1	0.90	1	
Common Mode Rejection Ratio[c]	CMRR	V_{DG} = 10 to 20 V I_D = 2 mA	76							dB

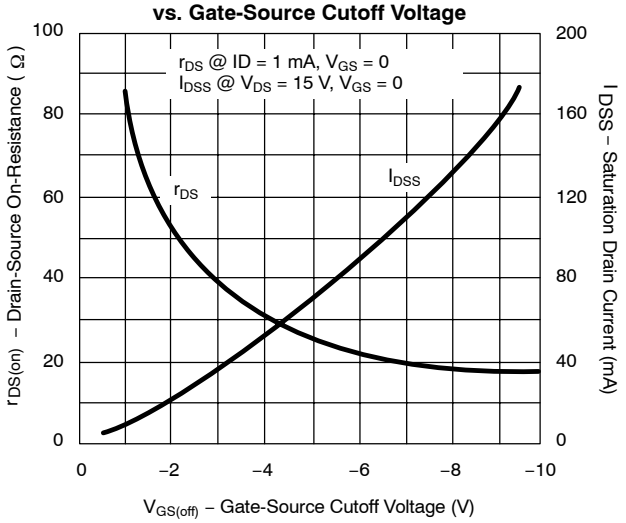
Notes
a. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
b. Pulse test: PW ≤300 μs duty cycle ≤3%.
c. This parameter not registered with JEDEC.
d. Not a production test.

NCBD

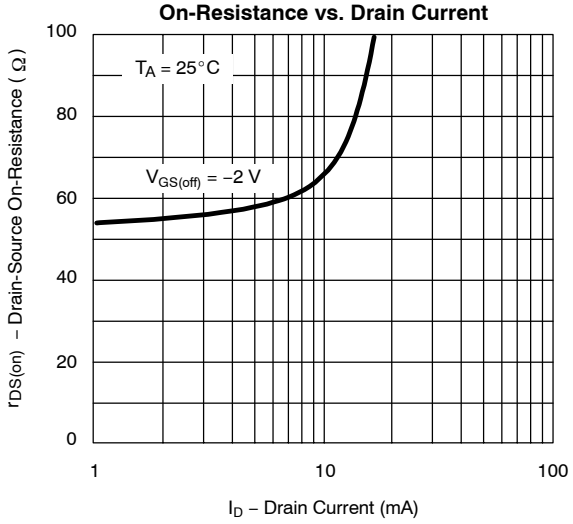
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (T_A = 25°C UNLESS OTHERWISE NOTED)

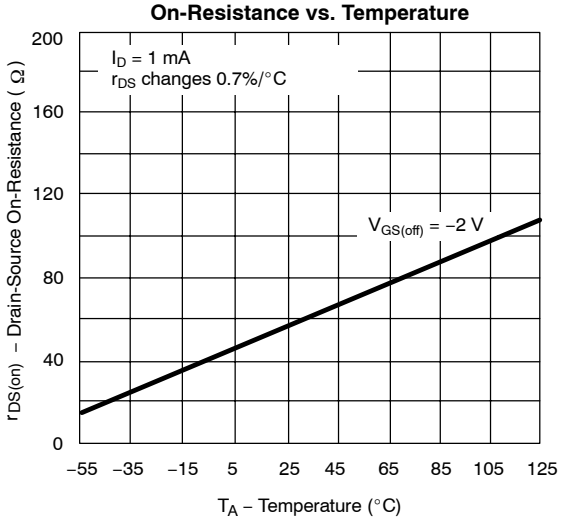
On-Resistance and Drain Current vs. Gate-Source Cutoff Voltage



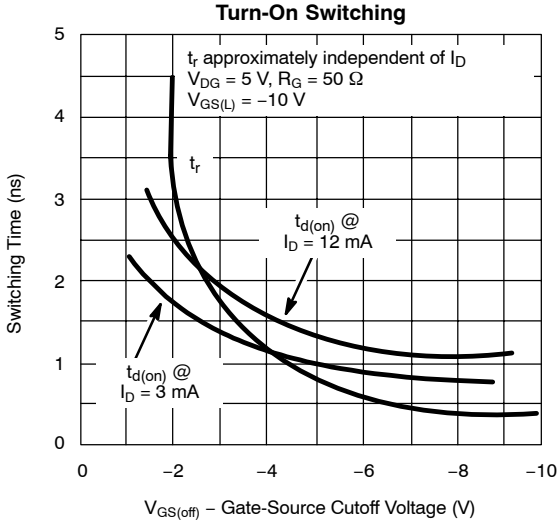
On-Resistance vs. Drain Current



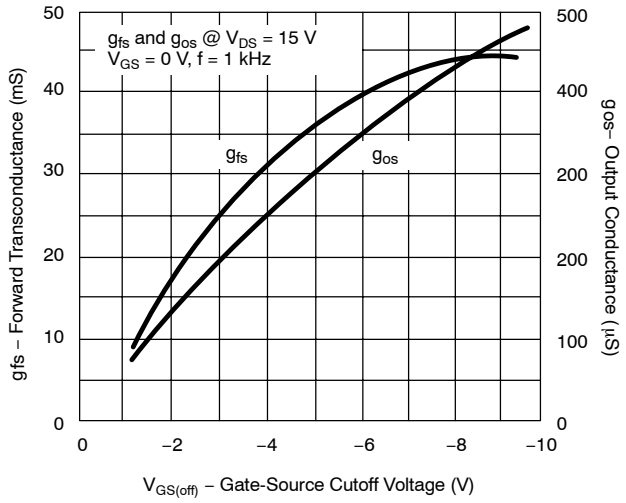
On-Resistance vs. Temperature



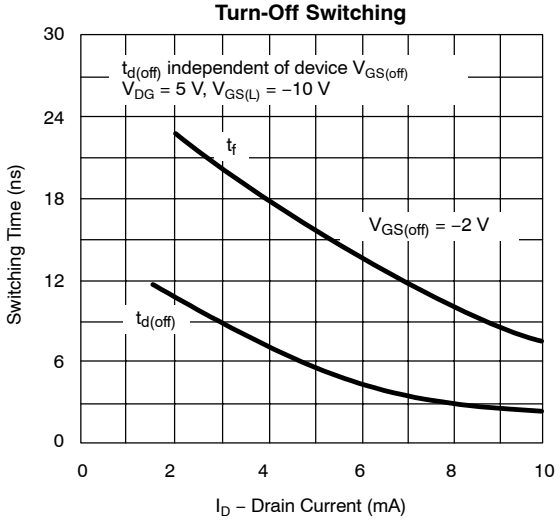
Turn-On Switching



Forward Transconductance and Output Conductance vs. Gate-Source Cutoff Voltage

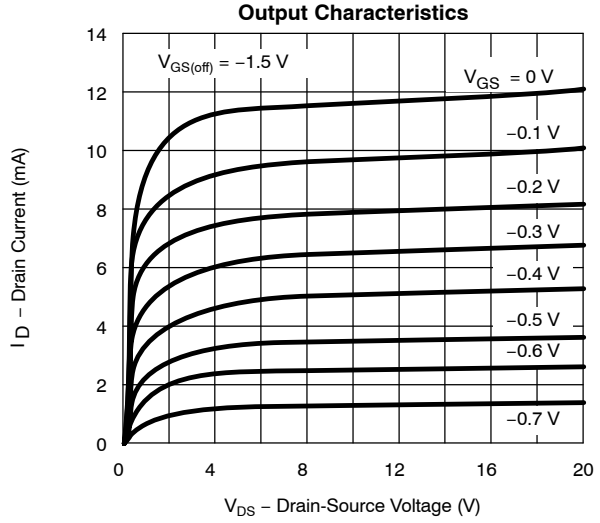


Turn-Off Switching

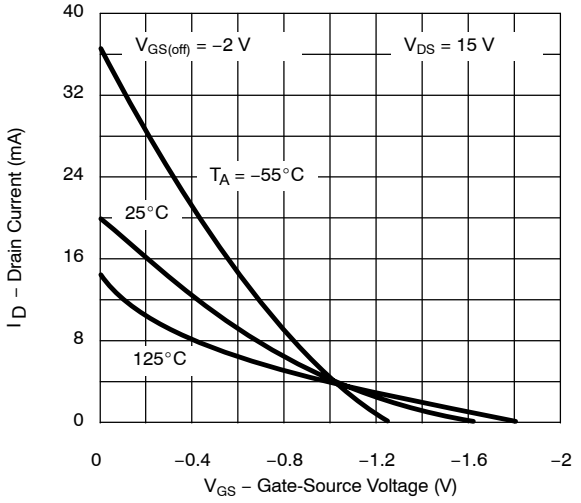


TYPICAL CHARACTERISTICS (T_A = 25°C UNLESS OTHERWISE NOTED)

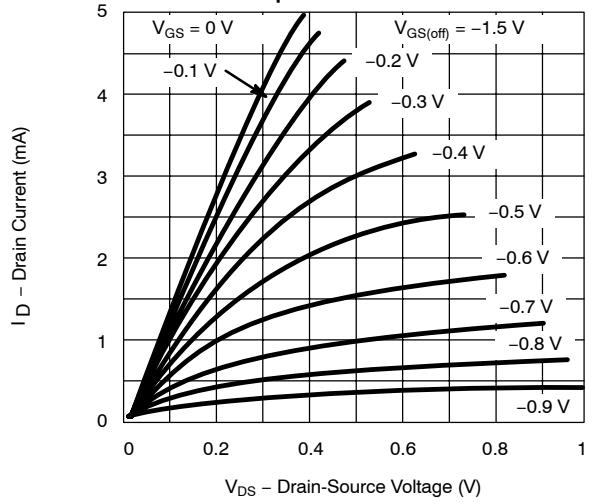
Output Characteristics



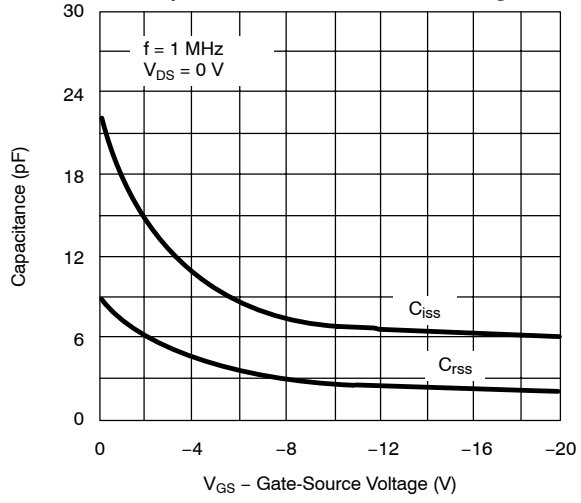
Transfer Characteristics



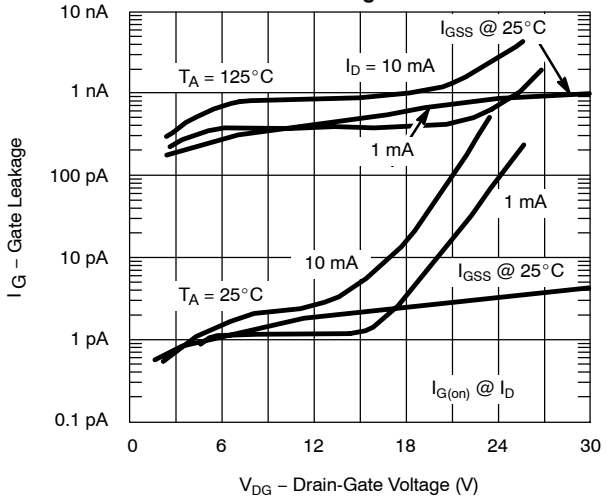
Output Characteristics



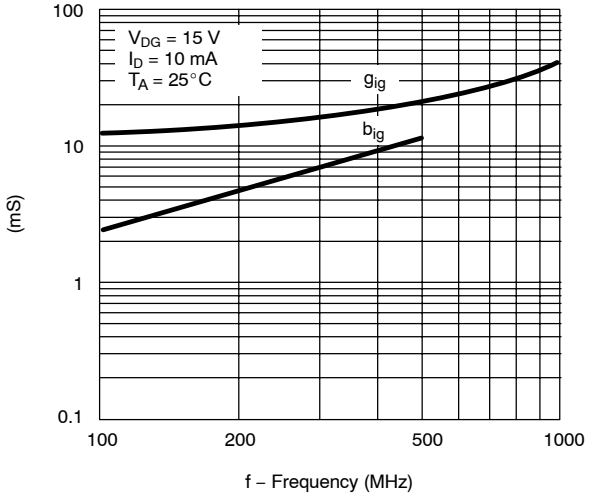
Capacitance vs. Gate-Source Voltage



Gate Leakage Current

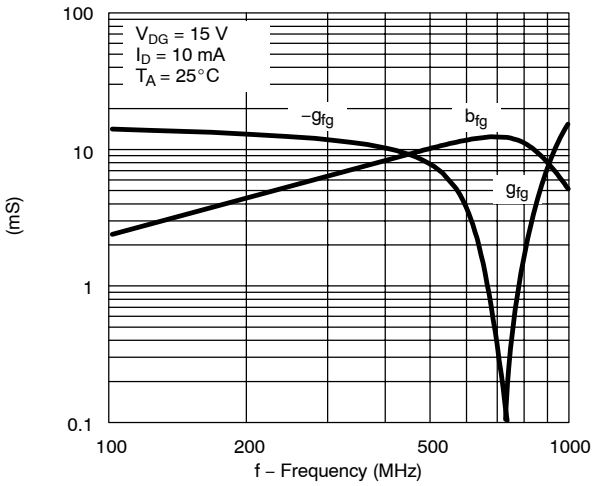


Common-Gate Input Admittance

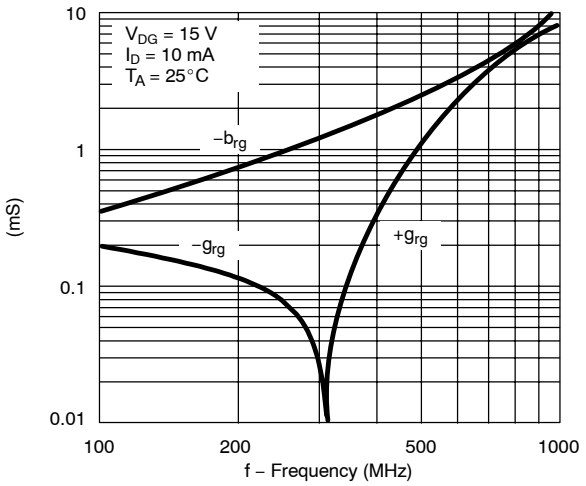


TYPICAL CHARACTERISTICS (T_A = 25°C UNLESS OTHERWISE NOTED)

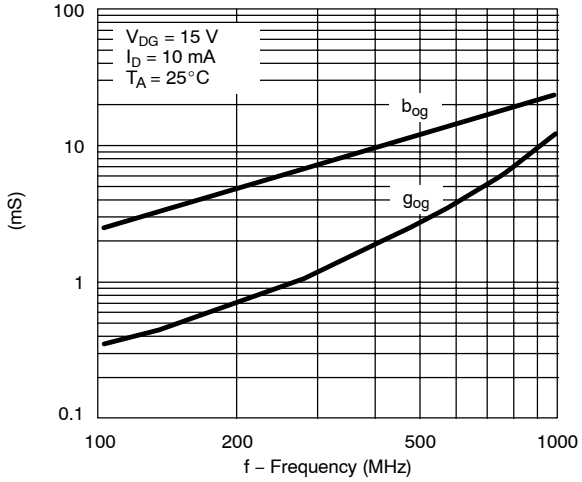
Common-Gate Forward Admittance



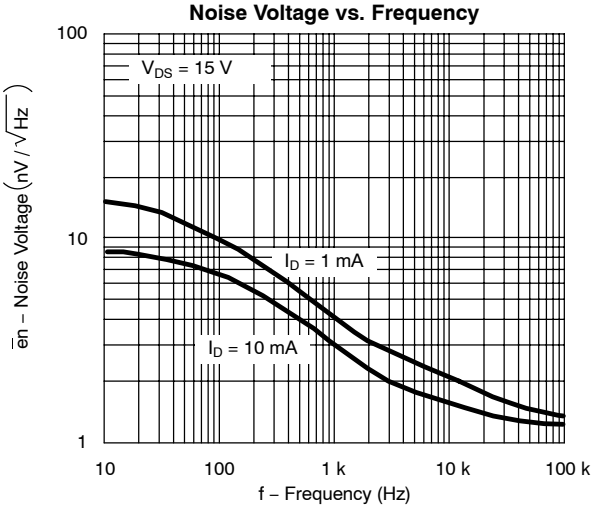
Common-Gate Reverse Admittance



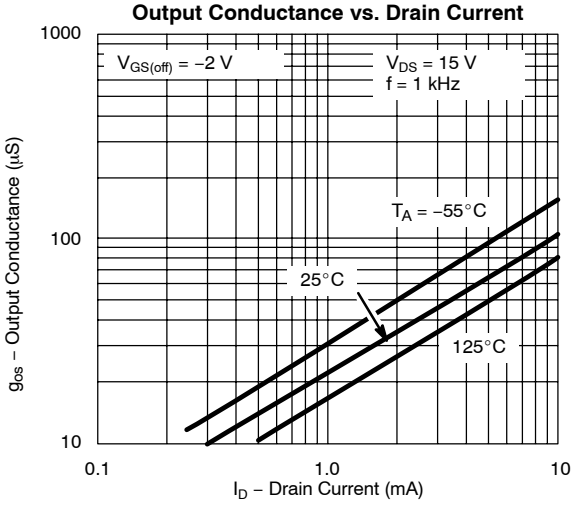
Common-Gate Output Admittance



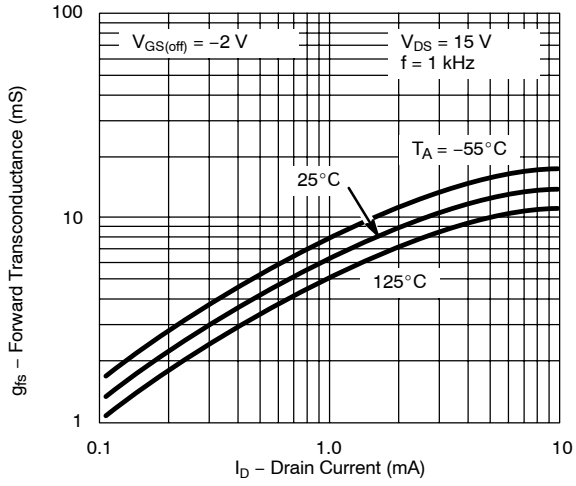
Noise Voltage vs. Frequency



Output Conductance vs. Drain Current



Transconductance vs. Drain Current



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